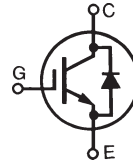


### BiMOSFET™ Monolithic Bipolar MOS Transistor

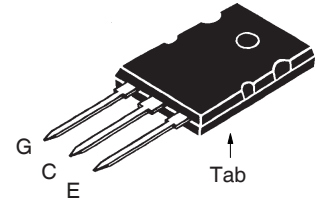
### IXBK75N170 IXBX75N170

$$\begin{aligned} V_{CES} &= 1700V \\ I_{C110} &= 75A \\ V_{CE(sat)} &\leq 3.1V \end{aligned}$$

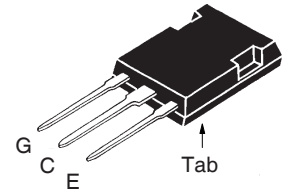


| Symbol         | Test Conditions                                                       | Maximum Ratings                 |                  |
|----------------|-----------------------------------------------------------------------|---------------------------------|------------------|
| $V_{CES}$      | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$                       | 1700                            | V                |
| $V_{CGR}$      | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ , $R_{GE} = 1M\Omega$ | 1700                            | V                |
| $V_{GES}$      | Continuous                                                            | $\pm 20$                        | V                |
| $V_{GEM}$      | Transient                                                             | $\pm 30$                        | V                |
| $I_{C25}$      | $T_C = 25^\circ\text{C}$ (Chip Capability)                            | 200                             | A                |
| $I_{LRMS}$     | $T_C = 25^\circ\text{C}$ (Lead RMS Limit)                             | 160                             | A                |
| $I_{C110}$     | $T_C = 110^\circ\text{C}$                                             | 75                              | A                |
| $I_{CM}$       | $T_C = 25^\circ\text{C}$ , 1ms                                        | 580                             | A                |
| <b>SSOA</b>    | $V_{GE} = 15V$ , $T_{VJ} = 125^\circ\text{C}$ , $R_G = 1\Omega$       | $I_{CM} = 150$                  | A                |
| <b>(RBSOA)</b> | Clamped Inductive Load                                                | $V_{CE} \leq 0.8 \cdot V_{CES}$ |                  |
| $P_C$          | $T_C = 25^\circ\text{C}$                                              | 1040                            | W                |
| $T_J$          |                                                                       | $-55 \dots +150$                | $^\circ\text{C}$ |
| $T_{JM}$       |                                                                       | 150                             | $^\circ\text{C}$ |
| $T_{stg}$      |                                                                       | $-55 \dots +150$                | $^\circ\text{C}$ |
| $T_L$          | Maximum Lead Temperature for Soldering                                | 300                             | $^\circ\text{C}$ |
| $T_{SOLD}$     | 1.6 mm (0.062 in.) from Case for 10                                   | 260                             | $^\circ\text{C}$ |
| $M_d$          | Mounting Torque (TO-264 )                                             | 1.13/10                         | Nm/lb.in.        |
| $F_c$          | Mounting Force (PLUS247 )                                             | 20..120/4.5..27                 | N/lb.            |
| <b>Weight</b>  | TO-264                                                                | 10                              | g                |
|                | PLUS247                                                               | 6                               | g                |

TO-264 (IXBK)



PLUS247™ (IXBX)



G = Gate      C = Collector  
E = Emitter      Tab = Collector

#### Features

- International Standard Packages
- High Blocking Voltage
- High Current Handling Capability
- Anti-Parallel Diode

#### Advantages

- High Power Density
- Low Gate Drive Requirement
- Intergrated Diode Can Be Used for Protection

#### Applications

- Capacitor Discharge
- AC Switches
- Switch-Mode and Resonant-Mode Power Supplies
- UPS
- AC Motor Drives

| Symbol        | Test Conditions<br>( $T_J = 25^\circ\text{C}$ , Unless Otherwise Specified) | Characteristic Values |            |                          |
|---------------|-----------------------------------------------------------------------------|-----------------------|------------|--------------------------|
|               |                                                                             | Min.                  | Typ.       | Max.                     |
| $BV_{CES}$    | $I_C = 250\mu\text{A}$ , $V_{GE} = 0V$                                      | 1700                  |            | V                        |
| $V_{GE(th)}$  | $I_C = 1.5\text{mA}$ , $V_{CE} = V_{GE}$                                    | 2.5                   |            | 5.5 V                    |
| $I_{CES}$     | $V_{CE} = 0.8 \cdot V_{CES}$ , $V_{GE} = 0V$<br>$T_J = 125^\circ\text{C}$   |                       |            | 25 $\mu\text{A}$<br>2 mA |
| $I_{GES}$     | $V_{CE} = 0V$ , $V_{GE} = \pm 20V$                                          |                       |            | $\pm 100$ nA             |
| $V_{CE(sat)}$ | $I_C = I_{C110}$ , $V_{GE} = 15V$ , Note 1<br>$T_J = 125^\circ\text{C}$     |                       | 2.6<br>3.1 | 3.1 V<br>V               |

## Symbol Test Conditions

( $T_J = 25^\circ\text{C}$  Unless Otherwise Specified)

## Characteristic Values

|              |                                                                                                                                              | Min. | Typ. | Max.                   |
|--------------|----------------------------------------------------------------------------------------------------------------------------------------------|------|------|------------------------|
| $g_{fs}$     | $I_C = I_{C110}, V_{CE} = 10V, \text{Note 1}$                                                                                                | 34   | 56   | S                      |
| $C_{ies}$    | $V_{CE} = 25V, V_{GE} = 0V, f = 1\text{MHz}$                                                                                                 |      | 6930 | pF                     |
| $C_{oes}$    |                                                                                                                                              |      | 400  | pF                     |
| $C_{res}$    |                                                                                                                                              |      | 150  | pF                     |
| $Q_g$        | $I_C = I_{C110}, V_{GE} = 15V, V_{CE} = 0.5 \cdot V_{CES}$                                                                                   |      | 350  | nC                     |
| $Q_{ge}$     |                                                                                                                                              |      | 50   | nC                     |
| $Q_{gc}$     |                                                                                                                                              |      | 160  | nC                     |
| $t_{d(on)}$  | <b>Resistive load, <math>T_J = 25^\circ\text{C}</math></b><br>$I_C = I_{C110}, V_{GE} = 15V$<br>$R_G = 1\Omega, V_{CE} = 0.5 \cdot V_{CES}$  |      | 46   | ns                     |
| $t_r$        |                                                                                                                                              |      | 160  | ns                     |
| $t_{d(off)}$ |                                                                                                                                              |      | 260  | ns                     |
| $t_f$        |                                                                                                                                              |      | 440  | ns                     |
| $t_{d(on)}$  | <b>Resistive load, <math>T_J = 125^\circ\text{C}</math></b><br>$I_C = I_{C110}, V_{GE} = 15V$<br>$R_G = 1\Omega, V_{CE} = 0.5 \cdot V_{CES}$ |      | 47   | ns                     |
| $t_r$        |                                                                                                                                              |      | 230  | ns                     |
| $t_{d(off)}$ |                                                                                                                                              |      | 260  | ns                     |
| $t_f$        |                                                                                                                                              |      | 580  | ns                     |
| $R_{thJC}$   |                                                                                                                                              |      |      | $0.12^\circ\text{C/W}$ |
| $R_{thCS}$   |                                                                                                                                              | 0.15 |      | $^\circ\text{C/W}$     |

## Reverse Diode

## Symbol Test Conditions

( $T_J = 25^\circ\text{C}$  Unless Otherwise Specified)

## Characteristic Values

|          |                                                                              | Min. | Typ. | Max     |
|----------|------------------------------------------------------------------------------|------|------|---------|
| $V_F$    | $I_F = I_{C110}, V_{GE} = 0V, \text{Note 1}$                                 |      |      | 3.0 V   |
| $t_{rr}$ | $I_F = 37A, V_{GE} = 0V, -di_F/dt = 100A/\mu s$<br>$V_R = 100V, V_{GE} = 0V$ |      | 1.5  | $\mu s$ |
| $I_{RM}$ |                                                                              |      | 50   | A       |
| $Q_{RM}$ |                                                                              |      | 38.2 | $\mu C$ |

## Note

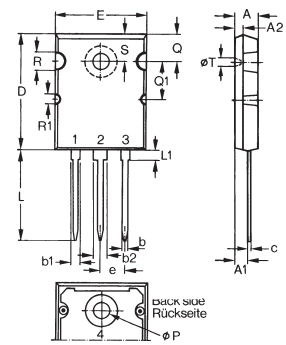
1. Pulse test,  $t \leq 300\mu s$ , duty cycle,  $d \leq 2\%$ .

Additional provisions for lead-to-lead isolation are required at  $V_{CE} > 1200V$ .

## PRELIMINARY TECHNICAL INFORMATION

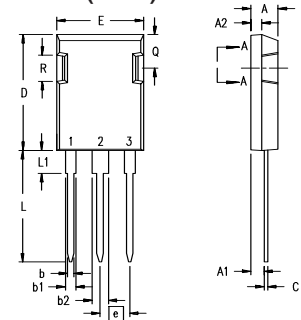
The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

## TO-264 AA (IXBK) Outline



| Dim. | Millimeter |       | Inches   |       |
|------|------------|-------|----------|-------|
|      | Min.       | Max.  | Min.     | Max.  |
| A    | 4.82       | 5.13  | .190     | .202  |
| A1   | 2.54       | 2.89  | .100     | .114  |
| A2   | 2.00       | 2.10  | .079     | .083  |
| b    | 1.12       | 1.42  | .044     | .056  |
| b1   | 2.39       | 2.69  | .094     | .106  |
| b2   | 2.90       | 3.09  | .114     | .122  |
| c    | 0.53       | 0.83  | .021     | .033  |
| D    | 25.91      | 26.16 | 1.020    | 1.030 |
| E    | 19.81      | 19.96 | .780     | .786  |
| e    | 5.46 BSC   |       | .215 BSC |       |
| J    | 0.00       | 0.25  | .000     | .010  |
| K    | 0.00       | 0.25  | .000     | .010  |
| L    | 20.32      | 20.83 | .800     | .820  |
| L1   | 2.29       | 2.59  | .090     | .102  |
| P    | 3.17       | 3.66  | .125     | .144  |
| Q    | 6.07       | 6.27  | .239     | .247  |
| Q1   | 8.38       | 8.69  | .330     | .342  |
| R    | 3.81       | 4.32  | .150     | .170  |
| R1   | 1.78       | 2.29  | .070     | .090  |
| S    | 6.04       | 6.30  | .238     | .248  |
| T    | 1.57       | 1.83  | .062     | .072  |

## PLUS247™ (IXBX) Outline



Terminals: 1 - Gate  
2 - Drain (Collector)  
3 - Source (Emitter)

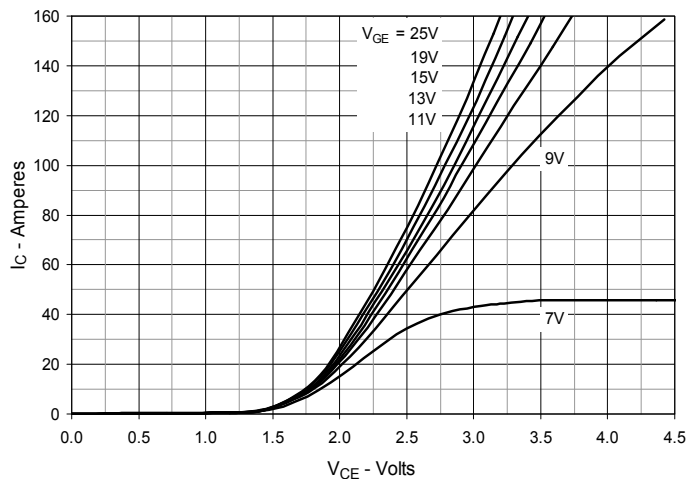
| Dim.           | Millimeter |       | Inches |       |
|----------------|------------|-------|--------|-------|
|                | Min.       | Max.  | Min.   | Max.  |
| A              | 4.83       | 5.21  | .190   | .205  |
| A <sub>1</sub> | 2.29       | 2.54  | .090   | .100  |
| A <sub>2</sub> | 1.91       | 2.16  | .075   | .085  |
| b              | 1.14       | 1.40  | .045   | .055  |
| b <sub>1</sub> | 1.91       | 2.13  | .075   | .084  |
| b <sub>2</sub> | 2.92       | 3.12  | .115   | .123  |
| C              | 0.61       | 0.80  | .024   | .031  |
| D              | 20.80      | 21.34 | .819   | .840  |
| E              | 15.75      | 16.13 | .620   | .635  |
| e              | 5.45       | BSC   | .215   | BSC   |
| L              | 19.81      | 20.32 | .780   | .800  |
| L1             | 3.81       | 4.32  | .150   | .170  |
| Q              | 5.59       | 6.20  | .220   | 0.244 |
| R              | 4.32       | 4.83  | .170   | .190  |

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

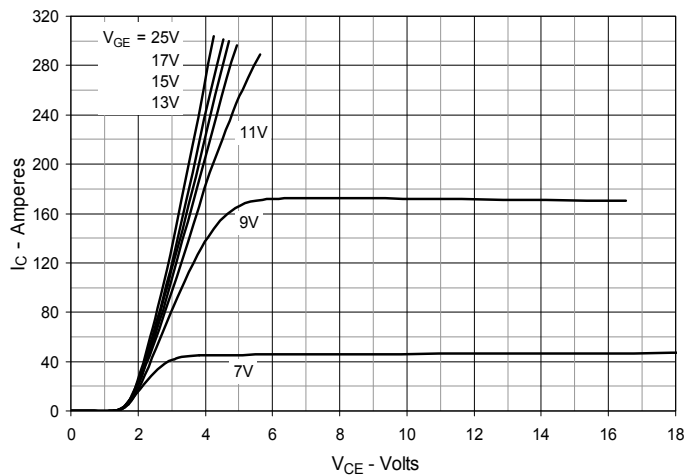
IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:

|           |           |           |           |              |              |              |              |              |              |
|-----------|-----------|-----------|-----------|--------------|--------------|--------------|--------------|--------------|--------------|
| 4,835,592 | 4,931,844 | 5,049,961 | 5,237,481 | 6,162,665    | 6,404,065 B1 | 6,683,344    | 6,727,585    | 7,005,734 B2 | 7,157,338 B2 |
| 4,850,072 | 5,017,508 | 5,063,307 | 5,381,025 | 6,259,123 B1 | 6,534,343    | 6,710,405 B2 | 6,759,692    | 7,063,975 B2 |              |
| 4,881,106 | 5,034,796 | 5,187,117 | 5,486,715 | 6,306,728 B1 | 6,583,505    | 6,710,463    | 6,771,478 B2 | 7,071,537    |              |

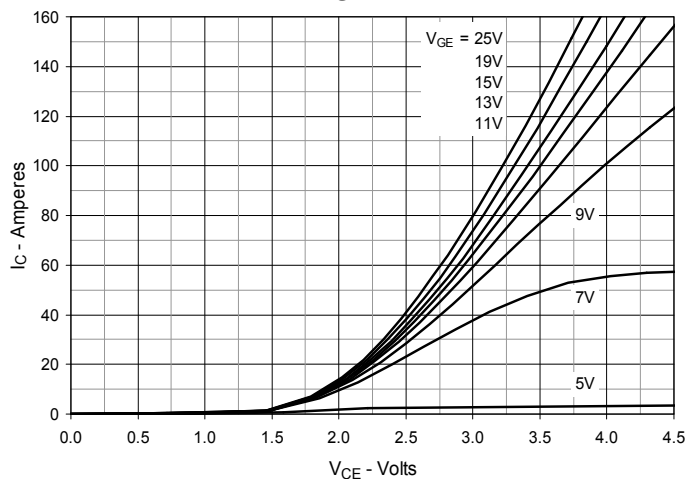
**Fig. 1. Output Characteristics**  
@ 25°C



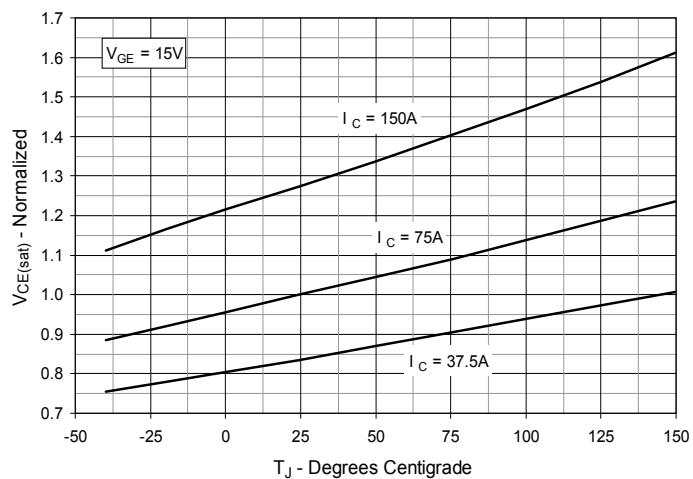
**Fig. 2. Extended Output Characteristics**  
@ 25°C



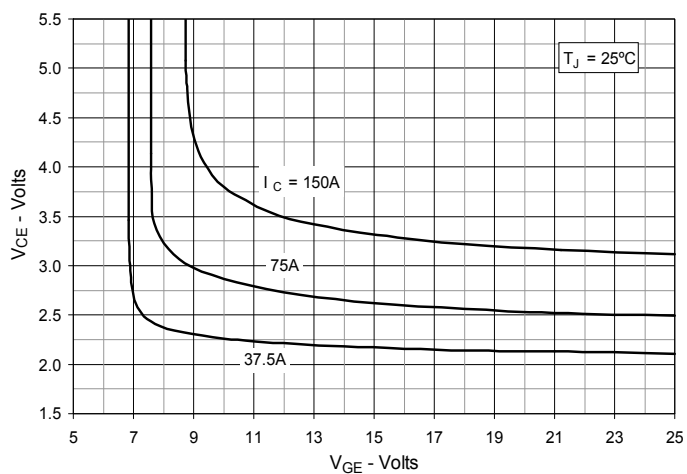
**Fig. 3. Output Characteristics**  
@ 125°C



**Fig. 4. Dependence of  $V_{CE(sat)}$  on**  
Junction Temperature



**Fig. 5. Collector-to-Emitter Voltage**  
vs. Gate-to-Emitter Voltage



**Fig. 6. Input Admittance**

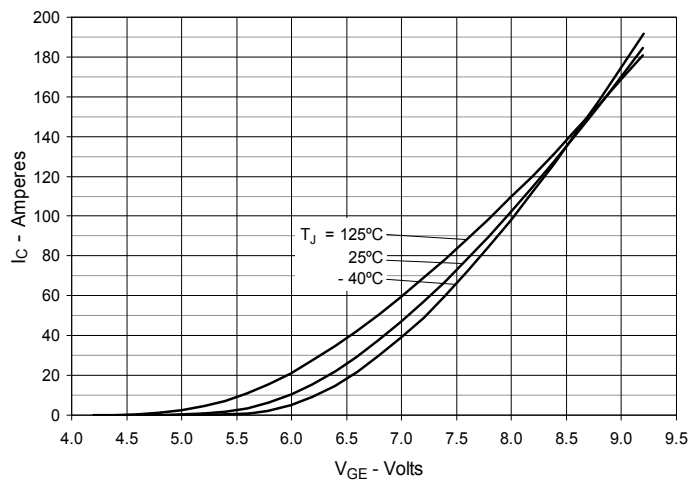


Fig. 7. Transconductance

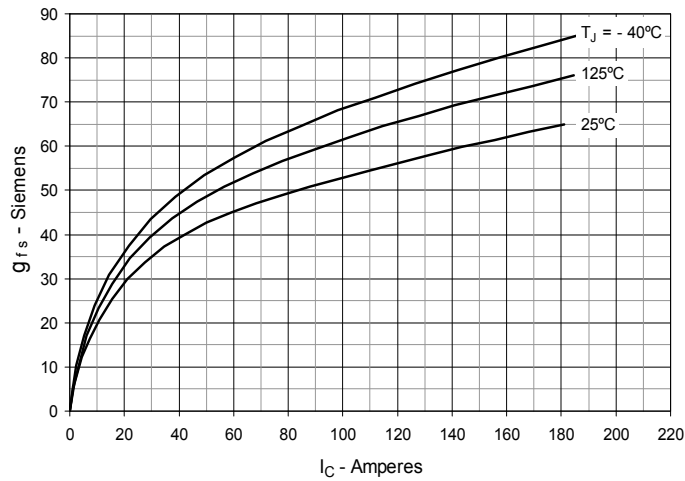


Fig. 8. Forward Voltage Drop of Intrinsic Diode

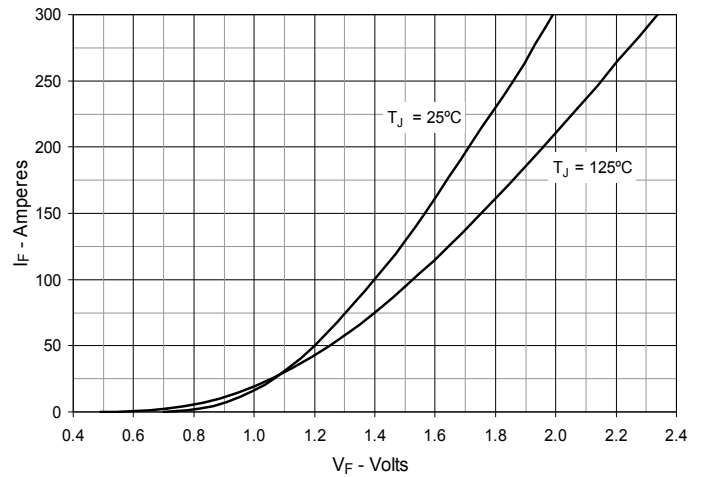


Fig. 9. Gate Charge

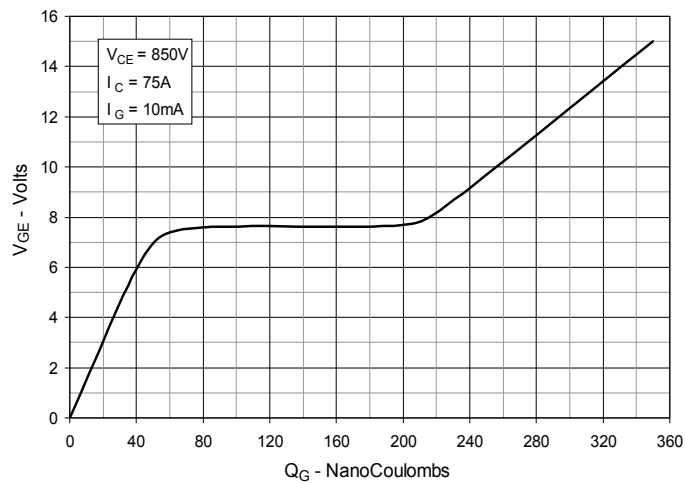


Fig. 10. Capacitance

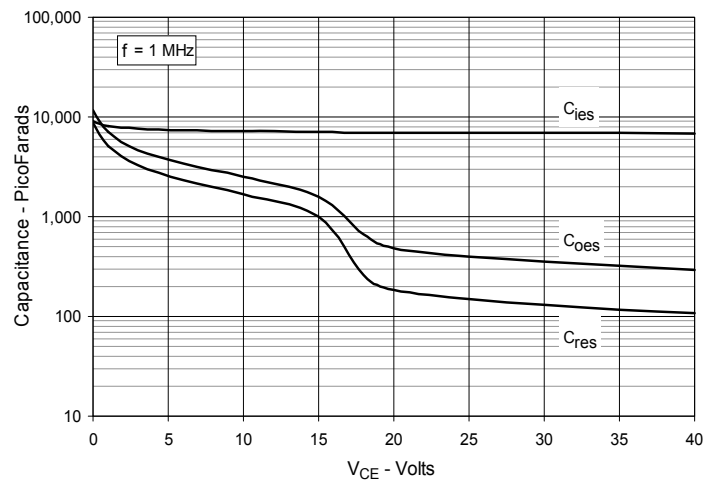


Fig. 11. Reverse-Bias Safe Operating Area

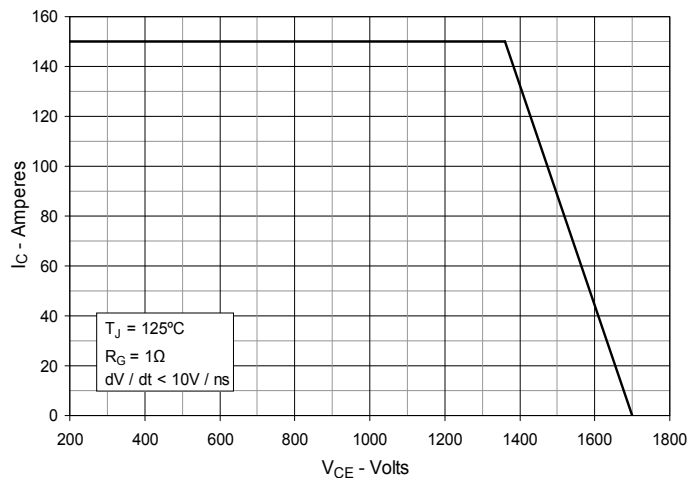
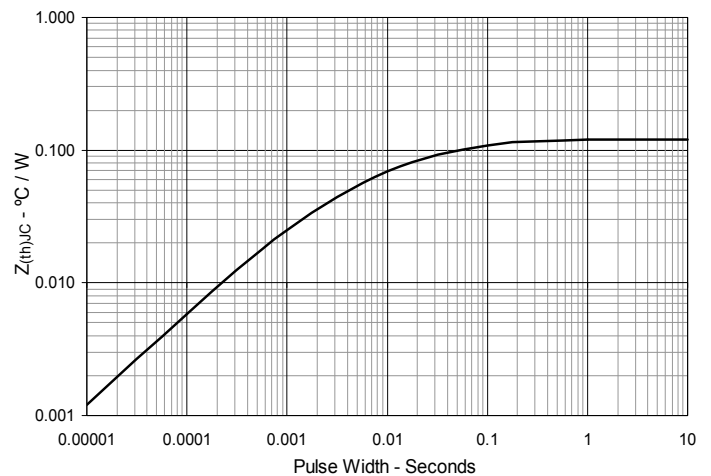
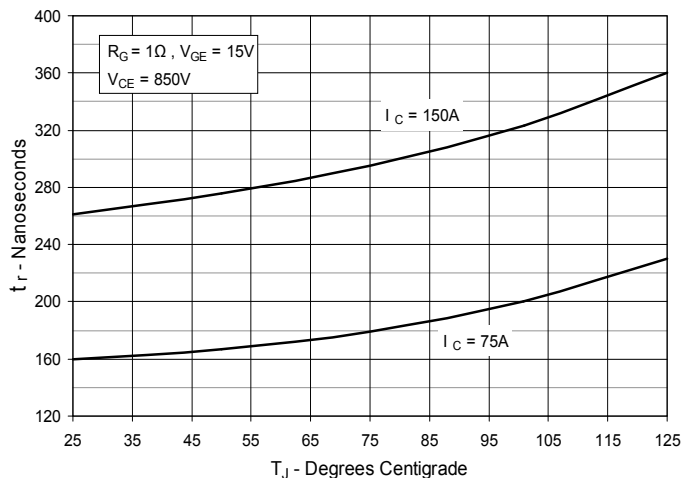


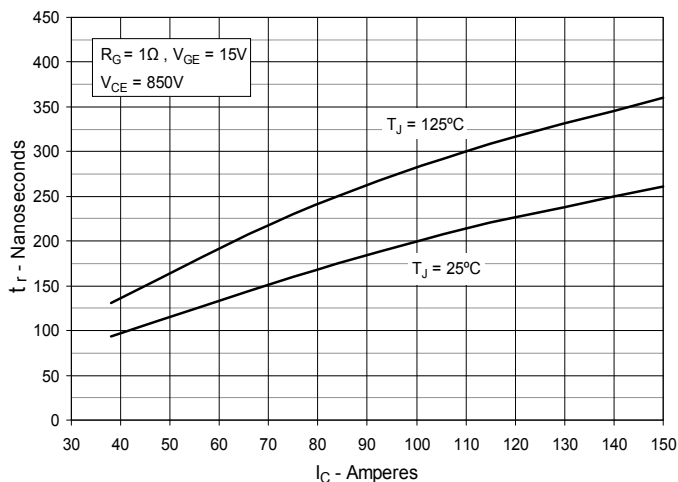
Fig. 12. Maximum Transient Thermal Impedance



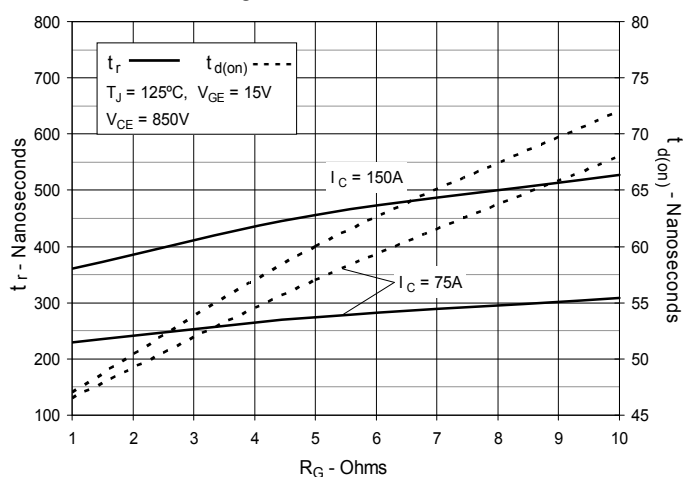
**Fig. 13. Resistive Turn-on**  
Rise Time vs. Junction Temperature



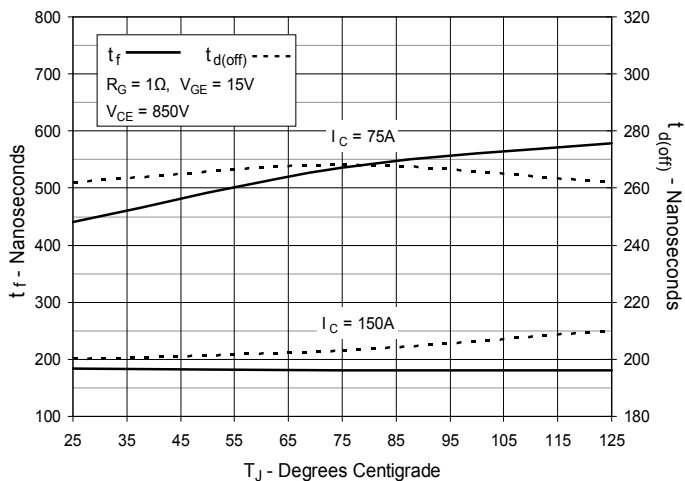
**Fig. 14. Resistive Turn-on**  
Rise Time vs. Collector Current



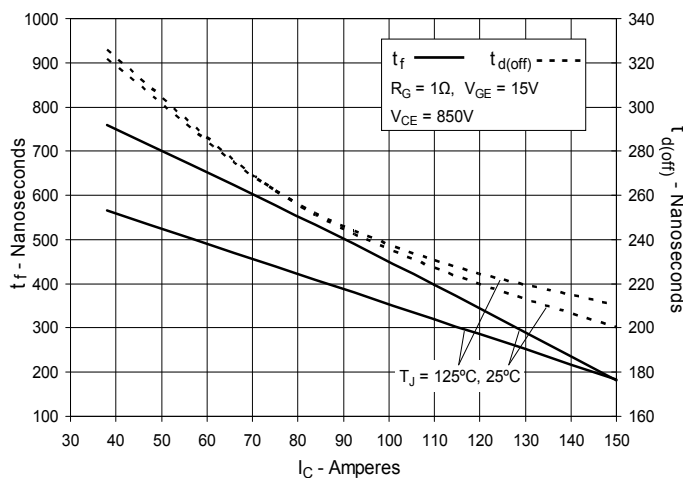
**Fig. 15. Resistive Turn-on**  
Switching Times vs. Gate Resistance



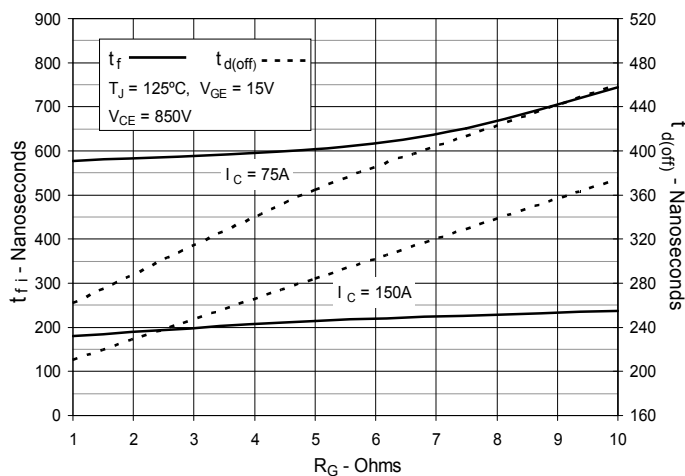
**Fig. 16. Resistive Turn-off**  
Switching Times vs. Junction Temperature



**Fig. 17. Resistive Turn-off**  
Switching Times vs. Collector Current



**Fig. 18. Resistive Turn-off**  
Switching Times vs. Gate Resistance





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